



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 10/734,419
Filing Date December 11, 2003
Inventor John T. Moore et al.
Assignee Micron Technology, Inc.
Group Art Unit 2815
Examiner Warren, Matthew E.
Attorney's Docket No. MI22-2463
Title: Semiconductor Wafer Assemblies Comprising Photoresist Over Silicon
Nitride Materials

TERMINAL DISCLAIMER

I, Jennifer J. Taylor, Ph.D., residing in the state of Washington, represent that I am the attorney of record for Micron Technology, Inc., a corporation of the state of Delaware. Micron Technology, Inc. is the owner of all right, title and interest of this U.S. Patent Application Serial No. 10/734,419, filed December 11, 2003, as evidenced by an assignment recorded May 24, 2000, Reel 010849, Frames 0405-0427 in the U.S. Patent and Trademark Office.

Micron Technology, Inc. is also the owner of all rights, title and interest in U.S. Patent Nos. 6,693,345 and 6,417,559, as evidenced by an assignment recorded May 24, 2000, at Reel 010849, Frames 0405-0427, in the U.S. Patent and Trademark Office.

The evidentiary documents have been reviewed, and I certify that, to the best of assignee's knowledge and belief, title is in the assignee seeking to take this action.

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Micron Technology, Inc. hereby disclaims the terminal part of any future patent granted on this U.S. Patent Application Serial No. 10/734,419 which extends beyond the expiration dates of U.S. Patent Nos. 6,693,345 and 6,417,559, and further hereby agrees that any future patent so granted on this U.S. Patent Application Serial No. 10/734,419 shall be enforceable only for and during such period that the legal titles on U.S. Patent Nos. 6,693,345 and 6,417,559 shall be the same as the legal title to any patent issued from U.S. Patent Application Serial No. 10/734,419. This agreement is to run with any patent granted on the application and is to be binding upon the grantee of such patent and its successors or assigns.

Micron Technology, Inc. does not disclaim any terminal part of any patent granted on this 10/734,419 application prior to the expiration dates of the full statutory terms of the United States Patent Nos. 6,693,345 and 6,417,559 in the event that they later: expire for failure to pay a maintenance fees, are held unenforceable, are found invalid by a court of competent jurisdiction, are statutorily disclaimed in whole or terminally disclaimed under 37 C.F.R. §1.321(a), have all claims canceled by a reexamination certificate, are reissued in any manner or are otherwise terminated prior to expiration of their full statutory term as presently shortened by any terminal disclaimer, except for the separation of legal title stated above.

The fee required by 37 C.F.R. 1.20(d) is submitted herewith. The Commissioner is hereby authorized to charge payment of any additional fees or credit overpayments to Deposit Account No. 23-0925.

The undersigned, Jennifer J. Taylor, Ph.D., hereby indicates that she is authorized to sign this document on behalf of the assignee, Micron Technology, Inc.

Respectfully submitted,

Dated: May 19, 2005

By: Jennifer J. Taylor
Jennifer J. Taylor, Ph.D.
Reg. No. 48,711